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March 2013

FSUSB46 — Hi-Speed USB2.0 (480Mbps) DPST Switch with Dedicated Charger Port Detection

Features

- Low On Capacitance: 7.0pF Typical
 Low On Resistance: 3.9Ω Typical
- Low Power Consumption: 1µA Maximum
 - 15 μ A Maximum I_{CCT} over an Expanded Voltage Range (V_{IN}=1.8V, V_{CC}=4.3V)
- Wide -3db Bandwidth: > 720MHz
- Packaged in Pb-free, 8-Lead MicroPak™ (1.6mm wide), US8 (3.1mm wide), and UMLP (1.4x1.4mm)
- 8kV ESD Rating, >16kV Power/GND ESD Rating
- Power-Off Protection on All Ports When V_{CC}=0V
 - D+/D- Pins Tolerate up to 5.25V

Applications

- Cell phone, PDA, Digital Camera, and Notebook
- LCD Monitor, TV, and Set-Top Box

IMPORTANT NOTE:

For additional performance information, please contact analogswitch@fairchildsemi.com.

Description

The FSUSB46 is a bi-directional, low-power, Hi-Speed, USB2.0 switch. Configured as a double-pole, single-throw switch (DPST) switch, it is optimized for switching a Hi-Speed (480Mbps) source.

The FSUSB46 is compatible with the requirements of USB2.0 and features an extremely low on capacitance (C_{ON}) of 3.9pF. The wide bandwidth of this device (720MHz) exceeds the bandwidth needed to pass the third harmonic, resulting in signals with minimum edge and phase distortion. Superior channel-to-channel crosstalk also minimizes interference.

The FSUSB46 contains special circuitry on the switch I/O pins for applications where the V_{CC} supply is powered-off ($V_{\text{CC}}{=}0$), which allows the device to withstand an over-voltage condition. This device is designed to minimize current consumption even when the control voltage applied to the /OE pin is lower than the supply voltage (V_{CC}). This feature is especially valuable to ultra-portable applications, such as cell phones, allowing for direct interface with the general-purpose I/Os of the baseband processor. An additional feature is the detection of the 1-1 (high/high) state on D+/D- to signal an interrupt (INT) to the processor when entering a dedicated charging port mode of operation.

Ordering Information

| Part Number | Operating Temperature Range | Package | © Eco Status |
|-------------------------|--------------------------------|---|--------------|
| FSUSB46L8X | -40 to +85°C | 8-Lead MicroPak™ 1.6mm Wide | RoHS |
| FSUSB46K8X | -40 to +85°C | 8-Lead US8, JEDEC MO187, Variation CA 3.1mm | Green |
| FSUSB46UMX -40 to +85°C | | 8-Lead Ultrathin Molded Leadless Package (UMLP), 1.2 x 1.4mm | Green |

For Fairchild's definition of Eco Status, please visit: http://www.fairchildsemi.com/company/green/rohs-green.html.

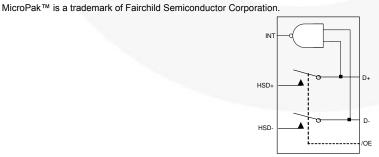
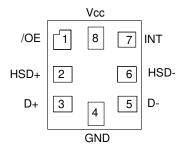
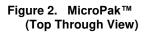


Figure 1. Analog Symbol

Pin Configurations





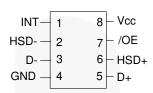


Figure 3. US8 (Top Through View)

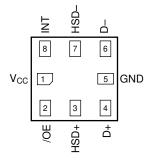


Figure 4. UMLP (Top Through View)

Pin Definitions

| Pin Name | Description |
|-----------------|--------------------------------|
| INT | Interrupt Signaling Output Pin |
| /OE | Switch Enable |
| D+, D- | USB Data Bus Connector |
| HSD+, HSD- | USB Source Inputs |
| GND | Ground |
| V _{CC} | Supply Voltage |

Truth Table

| Da | ta Path | Charger D | etect Path |
|------|-----------------------|-----------|------------|
| /OE | /OE Switch Connection | | INT Output |
| HIGH | D+, D- = Open | 1-1 | LOW |
| LOW | D+, D- = HSD+, HSD- | 0X, X0 | HIGH |

Absolute Maximum Ratings

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only.

| Symbol | Parameter | Parameter | | Max. | Unit |
|--------------------|---|--------------|-------|-----------------|------|
| V _{CC} | Supply Voltage | | -0.5 | +5.5 | V |
| V _{CNTRL} | DC Input Voltage (S) ⁽¹⁾ | | -0.5 | V _{CC} | V |
| V _{SW} | DC Switch I/O Voltage ⁽¹⁾ | | -0.50 | 5.25 | V |
| I _{IK} | DC Input Diode Current | | -50 | | mA |
| I _{OUT} | DC Output Current | | | 50 | mA |
| T _{STG} | Storage Temperature | | -65 | +150 | °C |
| | | All Pins | | 7 | |
| ESD | Human Body Model, JEDEC: JESD22-A114 | I/O to GND | | 8 | kV |
| LOD | | Power to GND | | 16 | IX V |
| | Charged Device Model, JEDEC: JESD22-C10 | 01 | | 2 | |

Note:

1. The input and output negative ratings may be exceeded if the input and output diode current ratings are observed.

Recommended Operating Conditions

The Recommended Operating Conditions table defines the conditions for actual device operation. Recommended operating conditions are specified to ensure optimal performance to the datasheet specifications. Fairchild does not recommend exceeding them or designing to Absolute Maximum Ratings.

| Symbol | Parameter | Min. | Max. | Unit |
|--------------------|--|------|-----------------|------|
| V _{CC} | Supply Voltage | 3.0 | 4.3 | ٧ |
| V _{CNTRL} | Control Input Voltage (/OE) ⁽²⁾ | 0 | V _{CC} | ٧ |
| V_{SW} | Switch I/O Voltage | -0.5 | V _{CC} | V |
| T _A | Operating Temperature | -40 | +85 | °C |

Note:

2. The control input must be held HIGH or LOW; it must not float.

DC Electrical Characteristics

All typical value are at 25°C, V_{CC} =3.3V unless otherwise specified.

| 0 | D | O a sa ditii a sa a | | | T _A =- 40°C to +85°C | | |
|------------------|---|--|---------------------|------|---------------------------------|------|----------|
| Symbol | Parameter Conditions | | V _{CC} (V) | Min. | Тур. | Max. | Units |
| V _{IK} | Clamp Diode Voltage | I _{IN} =-18mA | 3.0 | | | -1.2 | V |
| V _{IH} | Input Voltage High | | 3.0 to 3.6 | 1.3 | | | ٧ |
| VIH | input voitage riigii | | 4.3 | 1.7 | | | ٧ |
| V _{IL} | Input Voltage Low | | 3.0 to 3.6 | | | 0.5 | ٧ |
| V IL | input voitage Low | | 4.3 | | | 0.7 | V |
| V | Output Voltage High | 1 2mA | 3.0 to 3.6 | 2.4 | | | V |
| V _{OH} | Output Voltage High | I _{OH} =-2mA | 4.3 | 2.4 | | | V |
| V | Output Valtage Law | I Om A | 3.0 to 3.6 | | | 0.25 | V |
| V _{OL} | Output Voltage Low | I _{OL} =2mA | 4.3 | | | 0.25 | V |
| I _{IN} | Control Input Leakage | V _{SW} =0 to V _{CC} | 4.3 | -1 | | 1 | μΑ |
| l _{OZ} | Off State Leakage | HSD+ or HSD-=0V, 3.6V or floating | 4.3 | -2 | | 2 | μΑ |
| I _{OFF} | Power-Off Leakage Current (All I/O Ports) | V _{SW} =0V to 4.3V, V _{CC} =0V Figure 6 | 0 | -2 | | 2 | μΑ |
| R _{ON} | HS Switch On Resistance ⁽³⁾ | V _{SW} =0.4V, I _{ON} =-8mA Figure 5 | 3.0 | | 3.9 | 6.5 | Ω |
| ΔR_{ON} | HS Delta R _{ON} ⁽⁴⁾ | V _{SW} =0.4V, I _{ON} =-8mA | 3.0 | | 0.65 | | Ω |
| I _{CC} | Quiescent Supply Current | V _{CNTRL} =0 or V _{CC} , I _{OUT} =0 | 4.3 | | | 1 | μΑ |
| | Increase in I _{CC} Current Per | V _{CNTRL} =2.6V V _{CC} =4.3V | 4.3 | | | 10 | μΑ |
| I _{CCT} | Control Voltage and V _{CC} | | 4.3 | | | 20 | μΑ |

Notes:

- 3. Measured by the voltage drop between HSDn and Dn pins at the indicated current through the switch. On resistance is determined by the lower of the voltage on the two (HSDn or Dn ports).
- 4. Guaranteed by characterization.

AC Electrical Characteristics

All typical value are for V_{CC} =3.3V at 25°C unless otherwise specified.

| Symbol Parameter | | Conditions | V AA | T _A =- 4 | 40ºC to | +85ºC | Units |
|---------------------|--------------------------------------|---|---------------------|---------------------|---------|-------|-------|
| Symbol | Parameter | Conditions | V _{cc} (V) | Min. | Тур. | Max. | Units |
| t _{ON} | Turn-On Time /OE to Output | R_L =50 Ω , C_L =5pF V_{SW} =0.8V Figure 7, Figure 8 | 3.0 to 3.6 | | 13 | 30 | ns |
| t _{OFF} | Turn-Off Time /OE to Output | R_L =50 Ω , C_L =5pF V_{SW} =0.8V Figure 7, Figure 8 | 3.0 to 3.6 | | 12 | 25 | ns |
| t _{PD} | Propagation Delay ⁽⁵⁾ | $C_L=5$ pF, $R_L=50\Omega$ Figure 7, Figure 9 | 3.3 | | 0.25 | | ns |
| t _{BBM} | Break-Before-Make | R_L =50 Ω , C_L =5pF V_{SW1} = V_{SW2} =0.8V Figure 13 | 3.0 to 3.6 | 2.0 | | 6.5 | ns |
| t _{PLH/HL} | INT Propagation Delay ⁽⁵⁾ | $R_L=500\Omega$, $C_L=5pF$ | 3.0 to 3.6 | | 10 | | ns |
| O _{IRR} | Off Isolation | R _L =50Ω, f=240MHz Figure 15 | 3.0 to 3.6 | | -30 | | dB |
| Xtalk | Non-Adjacent Channel Crosstalk | R_L =50 Ω , f=240MHz Figure 16 | 3.0 to 3.6 | | -45 | | dB |
| BW | -3db Bandwidth | R_L =50 Ω , C_L =0pF Figure 14 | 3.0 to 3.6 | | 720 | A | MHz |
| DVV | -Sub Balluwidth | R_L =50 Ω , C_L =5pF Figure 14 | 3.0 (0 3.6 | | 550 | | MHz |

Note:

USB Hi-Speed-Related AC Electrical Characteristics

| Symbol | Parameter | Conditions | V (V) | T _A =- 40°C to +85°C | | | Units |
|--------------------|--|--|---------------------|---------------------------------|------|------|-------|
| Syllibol | Parameter | Conditions | V _{cc} (V) | Min. | Тур. | Max. | Uiiis |
| t _{SK(P)} | Skew of Opposite Transitions of the Same Output ⁽⁶⁾ | C_L =5pF, R_L =50 Ω Figure 10 | 3.0 to 3.6 | | 20 | | ps |
| tJ | Total Jitter ⁽⁶⁾ | $R_L=50\Omega$, $C_L=5pf$, $t_R=t_F=500ps$ (10-90%) at $480Mbps$ (PRBS= $2^{15}-1$) | 3.0 to 3.6 | | 200 | | ps |

Note:

6. Guaranteed by characterization.

Capacitance

| Symbol Parameter | | Conditions | T _A =- 40°C to +85°C | | | Units |
|------------------|-------------------------------|--|---------------------------------|------|------|--------|
| Symbol | Farameter | Conditions | Min. | Тур. | Max. | Ullits |
| C _{IN} | Control Pin Input Capacitance | V _{CC} =0V | | 1.5 | | pF |
| C _{OUT} | INT Pin Output Capacitance | V _{CC} =0V | | 2.5 | | pF |
| C _{ON} | D+, D- On Capacitance | V _{CC} =3.3V, f=1MHz Figure 12 | | 7.0 | 7.9 | pF |
| C _{OFF} | D+, D- Off Capacitance | V _{CC} =3.3V Figure 11 | | 2.0 | | pF |

^{5.} Guaranteed by characterization.

Test Diagrams

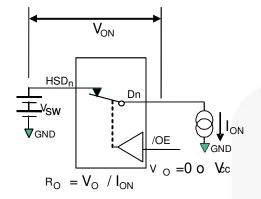
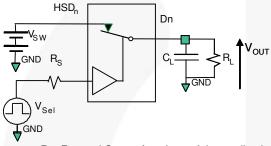


Figure 5. On Resistance



 R_L , R_S , and C_L are functions of the application environment (see AC Tables for specific values) C_L includes test fixture and stray capacitance.

Figure 7. AC Test Circuit Load

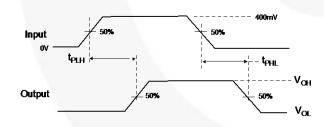


Figure 9. Propagation Delay (t_Rt_F - 500ps)

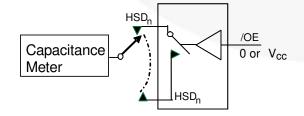


Figure 11. Channel Off Capacitance

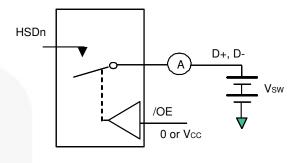


Figure 6. Off/On Leakage

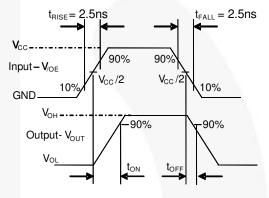


Figure 8. Turn-On / Turn-Off Waveforms

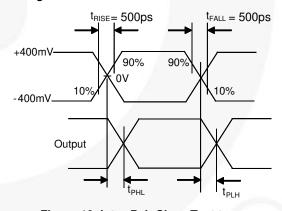


Figure 10. Intra-Pair Skew Test t_{SK(P)}

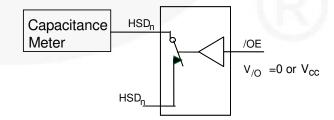


Figure 12. Channel On Capacitance

Test Diagrams (Continued)

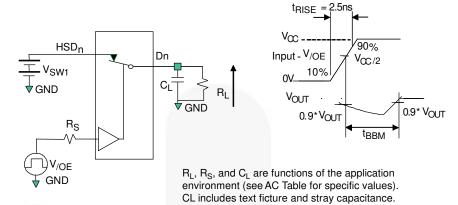
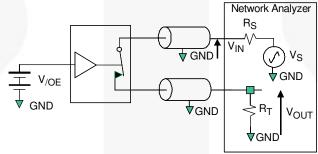


Figure 13. Break-Before-Make Interval Timing



 R_S , and R_T are functions of the application environment (see AC Table for specific values).

Figure 14. Bandwidth

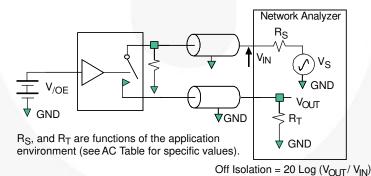


Figure 15. Channel Off Isolation

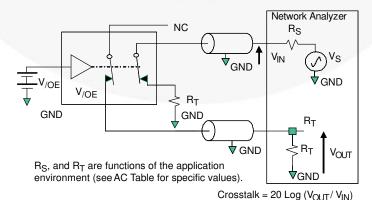
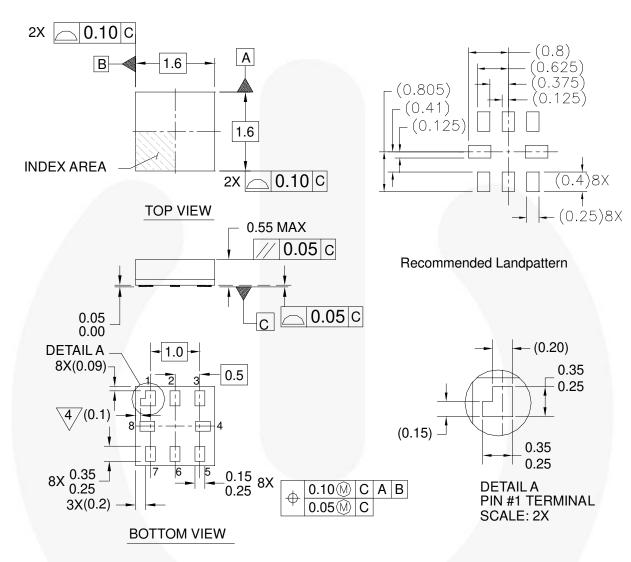


Figure 16. Non-Adjacent Channel-to-Channel Crosstalk

Physical Dimensions



Notes:

- 1. PACKAGE CONFORMS TO JEDEC MO-255 VARIATION UAAD
- 2. DIMENSIONS ARE IN MILLIMETERS
- 3. DRAWING CONFORMS TO ASME Y.14M-1994
- 4/PIN 1 FLAG, END OF PACKAGE OFFSET
- Š. DRAWING FILE NAME: MKT-MAC08AREV4

MAC08AREV4

Figure 17. 8-Lead MicroPak™

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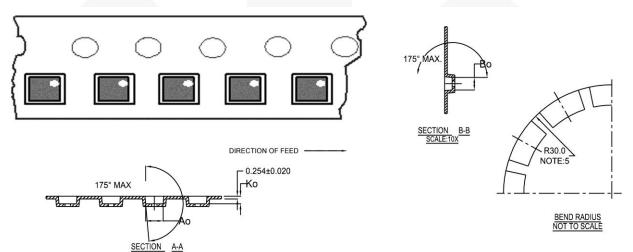
Tape and Reel Specifications

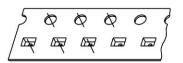
| Package Designator | Tape Section | Cavity Number | Cavity Status | Cover Tape Status |
|-----------------------|--------------------|---------------|---------------|----------------------|
| | Leader (Start End) | 125 (Typical) | Empty | Sealed |
| L6X, L8X, L10X | Carrier | 5000 | Filled | Sealed |
| | Trailer (Hub End) | 75 (Typical) | Empty | Sealed |

Standard Tape and Reel Specifications

Standard tape and reel specifications for MicroPak are available at Fairchild Semiconductor's website: http://www.fairchildsemi.com/products/logic/pdf/micropak tr.pdf

FSUSB46L8X_F130 Tape and Reel Specifications



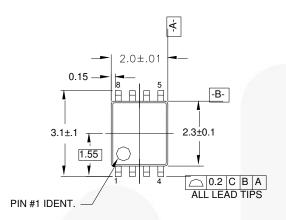


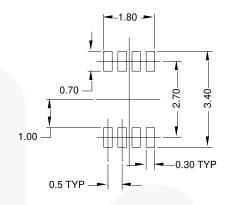
SCALE: 6X

- NOTES: UNLESS OTHERWISE SPECIFIED
- 1. ACCUMULATED 50 SPROCKETS, SPROCKET HOLE PITCH IS 200.00 ±0.30MM
- 2. NO INDICATED CORNER RADIUS IS 0.127MM
- 3. CAMBER NOT TO EXCEED 1MM IN 100MM
- 4. SMALLEST ALLOWABLE BENDING RADIUS
- 5. POCKET POSITION RELATIVE TO SPROCKET HOLE MEASURED AS TRUE POSITION OF POCKET, NOT POCKET HOLE

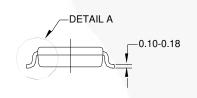
| 10 | 30056 | 2.30 ± 0.1mm | 1.78 ± 0.1mm | 0.68 ± 0.1mm |
|----|-------|--------------|--------------|--------------|
| 8 | 30038 | 1.78 ± 0.1mm | 1.78 ± 0.1mm | 0.68 ± 0.1mm |
| 6 | 30033 | 1.60 ± 0.1mm | 1.15 ± 0.1mm | 0.70 ± 0.1mm |

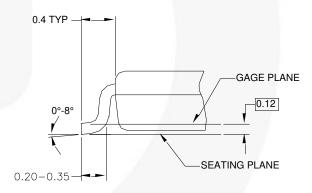
Physical Dimensions

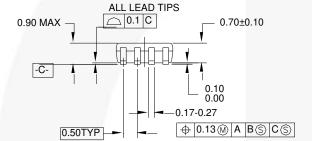




LAND PATTERN RECOMMENDATION







NOTES:

- A. CONFORMS TO JEDEC REGISTRATION MO-187
- B. DIMENSIONS ARE IN MILLIMETERS.
- C. DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH, AND TIE BAR EXTRUSIONS.
- D. DIMENSIONS AND TOLERANCES PER ANSI Y14.5M, 1982.

DETAIL A

MAB08AREVC

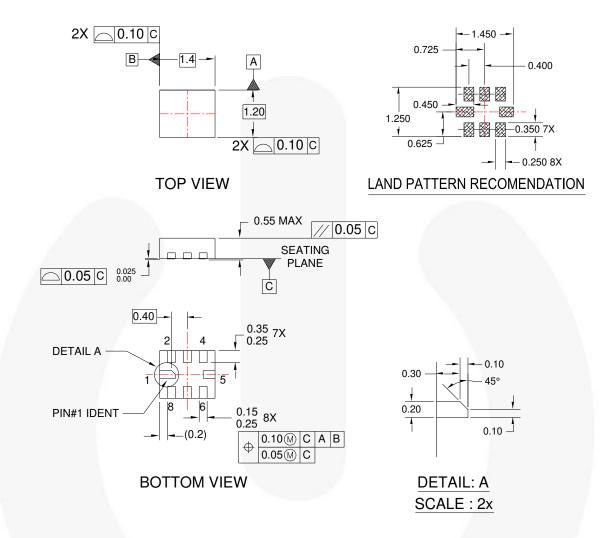
Figure 18. 8-Lead US8, JEDEC MO-187

For current tape and reel specifications, visit Fairchild Semiconductor's online packaging area: http://www.fairchildsemi.com/ms/MS-522.pdf

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Physical Dimensions



NOTES:

- A. DOES NOT CONFORMS TO JEDEC STANDARD.
- B. DIMENSIONS ARE IN MILLIMETERS.
- C. DIMENSIONS AND TOLERANCES CONFORMS TO ASME Y14.5M. 1994.
- D. DRAWING FILE NAME: UMLP08Arev1

Figure 19. 8-Lead, Ultrathin Molded Leadless Package (UMLP), 1.2 x 1.4mm

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